High Temp

Resin for Heat Resistance

High Temp Resin offers a heat deflection temperature (HDT) of 238 °C @ 0.45 MPa, the highest among Formlabs resins. Use it to print detailed, precise prototypes with high temperature resistance.

Hot air, gas, and fluid flow   **Heat resistant mounts, housings, and fixtures**

Molds and inserts

(V2)   **FLHTAM02**   *** May not be available in all regions**

MATERIAL PROPERTIES DATA

High Temp Resin

	METRIC [1]			IMPERIAL [1]			METHOD
	Green [2]	Post-Cured [3]	Post-Cured + additional Thermal Cure [4]	Green [2]	Post-Cured [3]	Post-Cured + additional Thermal Cure [4]	
Tensile Properties							
Ultimate Tensile Strength	21 MPa	58 MPa	49 MPa	3031 psi	8456 psi	7063 psi	ASTM D638-14
Tensile Modulus	0.75 GPa	2.8 GPa	2.8 GPa	109 ksi	399 ksi	406 ksi	ASTM D638-14
Elongation at Break	14%	3.3%	2.3%	14%	3.3%	2.3%	ASTM D638-14
Flexural Properties							
Flexural Strength at Break	24 MPa	95 MPa	97 MPa	3495 psi	13706 psi	14097 psi	ASTM D 790-15
Flexural Modulus	0.7 GPa	2.6 GPa	2.8 GPa	100 ksi	400 ksi	406 ksi	ASTM D 790-15
Impact Properties							
Notched IZOD	33 J/m	18 J/m	17 J/m	0.61 ft-lbf/in	0.34 ft-lbf/in	0.32 ft-lbf/in	ASTM D256-10
Thermal Properties							
Heat Deflection Temp. @ 1.8 MPa	44 °C	78 °C	101 °C	111 °F	172 °F	214 °F	ASTM D 648-16
Heat Deflection Temp. @ 0.45 MPa	49 °C	120 °C	238 °C	120 °F	248 °F	460 °F	ASTM D 648-16
Thermal Expansion	118 µm/m/°C	80 µm/m/°C	75 µm/m/°C	41 µin/in/°F	44 µin/in/°F	41 µin/in/°F	ASTM E 831-13

[1] Material properties can vary with part geometry, print orientation, print settings, and temperature.

[2] Data was obtained from green parts, printed using Form 2, 100 µm, High Temp settings, washed for 5 minutes in Form Wash and air dried without post cure.

[3] Data was obtained from parts printed using a Form 2, 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 60 minutes.

[4] Data was obtained from parts printed using a Form 2, 100 micron, High Temp settings, and post-cured with Form Cure at 80 °C for 120 minutes plus an additional thermal cure in a lab oven at 160 °C for 180 minutes.

SOLVENT COMPATIBILITY

Percent weight gain over 24 hours for a printed and post-cured 1 x 1 x 1 cm cube immersed in respective solvent:

Solvent	24 hr size gain, %	24 hr weight gain, %	Solvent	24 hr size gain, %	24 hr weight gain, %
Acetic Acid 5%	< 1	< 1	Mineral oil (Light)	< 1	< 1
Acetone	< 1	2	Mineral oil (Heavy)	< 1	< 1
Bleach ~5% NaOCl	< 1	< 1	Salt Water (3.5% NaCl)	< 1	< 1
Butyl Acetate	< 1	< 1	Skydrol 5	< 1	1.1
Diesel Fuel	< 1	< 1	Sodium Hydroxide solution (0.025% PH 10)	< 1	< 1
Diethyl glycol Monomethyl Ether	< 1	1	Strong Acid (HCl conc)	1.2	< 1
Hydraulic Oil	< 1	< 1	Tripropylene glycol monomethyl ether	< 1	< 1
Hydrogen peroxide (3%)	< 1	< 1	Water	< 1	< 1
Isooctane (aka gasoline)	< 1	< 1	Xylene	< 1	< 1
Isopropyl Alcohol	< 1	< 1			